MS S35200MRGHMGG

35 V, 5 A, Low V_{CE(sat)} PNP Transistor

ON Semiconductor's e²PowerEdge family of low $V_{CE(sat)}$ transistors are miniature surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical application are DC–DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

• This is a Pb–Free Device

MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	-35	Vdc
Collector-Base Voltage	V _{CBO}	-55	Vdc
Emitter-Base Voltage	V _{EBO}	-5.0	Vdc
Collector Current – Continuous	۱ _C	-2.0	Adc
Collector Current – Peak	I _{CM}	-5.0	А
Electrostatic Discharge	ESD	HBM Class 3 MM Class C	

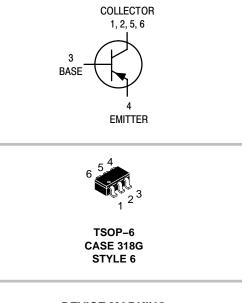
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



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$\begin{array}{c} 35 \text{ VOLTS} \\ 5.0 \text{ AMPS} \end{array} \\ \textbf{PNP LOW V}_{CE(sat)} \text{ TRANSISTOR} \\ \textbf{EQUIVALENT R}_{DS(on)} 100 \text{ m}\Omega \end{array}$



DEVICE MARKING



VS8 = Specific Device Code M = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NSS35200MR6T1G	TSOP-6 (Pb-Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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Characteristic	Symbol	Мах	Unit	
Total Device Dissipation $T_A = 25^{\circ}C$	P _D (Note 1)	625	mW	
Derate above 25°C		5.0	mW/°C	
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 1)	200	°C/W	
Total Device Dissipation $T_A = 25^{\circ}C$	P _D (Note 2)	1.0	W	
Derate above 25°C		8.0	mW/°C	
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 2)	120	°C/W	
Thermal Resistance, Junction-to-Lead #1	R _{θJL}	80	°C/W	
Total Device Dissipation (Single Pulse < 10 sec.)	P _{Dsingle} (Notes 2 & 3)	1.75	W	
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C	

FR-4 @ Minimum Pad.
FR-4 @ 1.0 X 1.0 inch Pad.
Refer to Figure 9.

查记了TRICAL CHARACTERISTIC会(标音25°C unless otherwise noted)

Characteristic	Symbol	Min	Typical	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage $(I_{C} = -10 \text{ mAdc}, I_{B} = 0)$	V _{(BR)CEO}	-35	-45	-	Vdc
Collector – Base Breakdown Voltage ($I_C = -0.1 \text{ mAdc}, I_E = 0$)	V _{(BR)CBO}	-55	-65	-	Vdc
Emitter – Base Breakdown Voltage ($I_E = -0.1 \text{ mAdc}, I_C = 0$)	V _{(BR)EBO}	-5.0	-7.0	_	Vdc
Collector Cutoff Current ($V_{CB} = -35$ Vdc, $I_E = 0$)	I _{CBO}	_	-0.03	-0.1	μAdc
Collector–Emitter Cutoff Current (V _{CES} = -35 Vdc)	I _{CES}	_	-0.03	-0.1	μAdc
Emitter Cutoff Current (V _{EB} = -4.0 Vdc)	I _{EBO}	_	-0.01	-0.1	μAdc
ON CHARACTERISTICS				•	
DC Current Gain (Note 4) $(I_C = -1.0 \text{ A}, V_{CE} = -1.5 \text{ V})$ $(I_C = -1.5 \text{ A}, V_{CE} = -1.5 \text{ V})$ $(I_C = -2.0 \text{ A}, V_{CE} = -3.0 \text{ V})$	h _{FE}	100 100 100	200 200 200	_ 400 _	
Collector – Emitter Saturation Voltage (Note 4) ($I_C = -0.8 \text{ A}, I_B = -0.008 \text{ A}$) ($I_C = -1.2 \text{ A}, I_B = -0.012 \text{ A}$) ($I_C = -2.0 \text{ A}, I_B = -0.02 \text{ A}$)	V _{CE(sat)}	- - -	-0.125 -0.175 -0.260	-0.15 -0.20 -0.31	V
Base – Emitter Saturation Voltage (Note 4) $(I_C = -1.2 \text{ A}, I_B = -0.012 \text{ A})$	V _{BE(sat)}	_	-0.68	-0.85	V
Base – Emitter Turn–on Voltage (Note 4) ($I_C = -2.0 \text{ A}, V_{CE} = -3.0 \text{ V}$)	V _{BE(on)}	_	-0.81	-0.875	V
Cutoff Frequency (I _C = -100 mA, V _{CE} = -5.0 V, f = 100 MHz)	f _T	100	-	-	MHz
Input Capacitance ($V_{EB} = -0.5 \text{ V}$, f = 1.0 MHz)	Cibo	_	600	650	pF
Output Capacitance ($V_{CB} = -3.0 \text{ V}, \text{ f} = 1.0 \text{ MHz}$)	Cobo	_	85	100	pF
Turn–on Time (V_{CC} = –10 V, I_{B1} = –100 mA, I_{C} = –1 A, R_{L} = 3 Ω)	t _{on}	_	35	-	nS
Turn–off Time (V _{CC} = –10 V, $I_{B1} = I_{B2} = -100$ mA, $I_C = 1$ A, $R_L = 3 \Omega$)	t _{off}	_	225	-	nS

4. Pulsed Condition: Pulse Width = 300 μ sec, Duty Cycle \leq 2%.

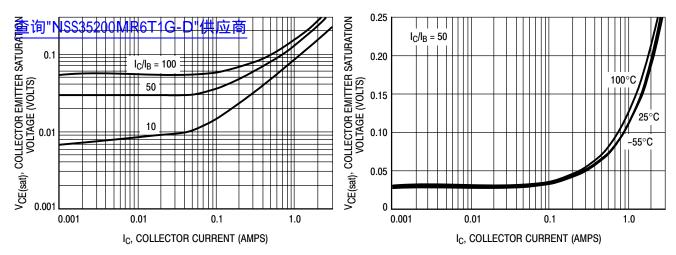


Figure 1. Collector Emitter Saturation Voltage versus Collector Current

1.6

1.4

1.2

1.0

0.8

0.6 0.4

0.2

0 0.001

1.1

1.0

0.9

0.8

0.7

0.6

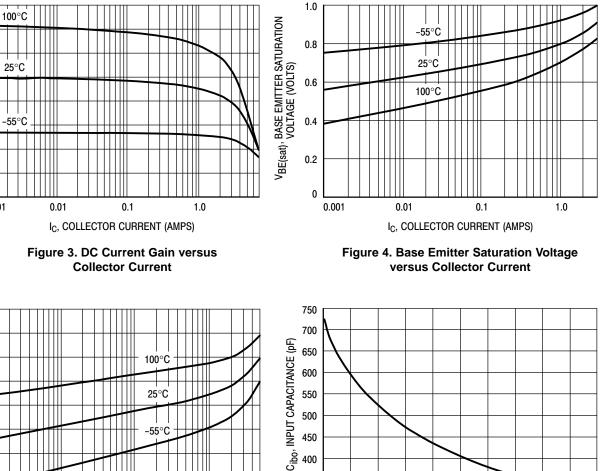
25°C

-55°C

h_{FE}, DC CURRENT GAIN (NORMALIZED)

VBE(on), BASE EMITTER TURN-ON VOLTAGE (VOLTS)

Figure 2. Collector Emitter Saturation Voltage versus Collector Current



400

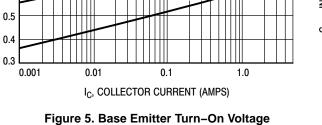
350 300

> 0 0.5

1.0

1.5

2.0 2.5



versus Collector Current

Figure 6. Input Capacitance

V_{EB}, EMITTER BASE VOLTAGE (VOLTS)

3.0

3.5

4.0

4.5 5.0

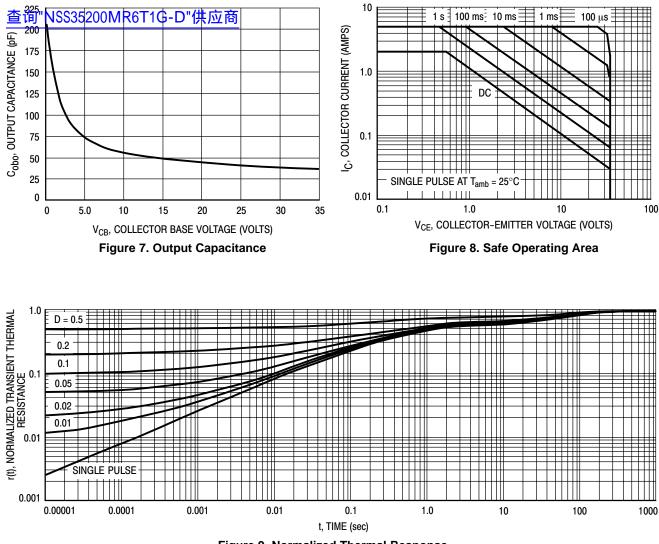
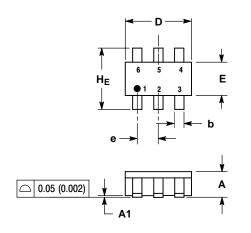


Figure 9. Normalized Thermal Response

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PACKAGE DIMENSIONS

TSOP-6 CASE 318G-02 **ISSUE P**



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF 3
- BASE MATERIAL. DIMENSIONS A AND B DO NOT INCLUDE 4 MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

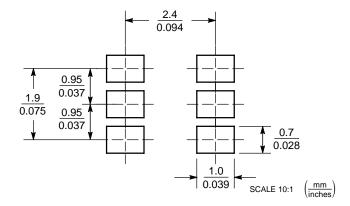
	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.90	1.00	1.10	0.035	0.039	0.043	
A1	0.01	0.06	0.10	0.001	0.002	0.004	
b	0.25	0.38	0.50	0.010	0.014	0.020	
С	0.10	0.18	0.26	0.004	0.007	0.010	
D	2.90	3.00	3.10	0.114	0.118	0.122	
Е	1.30	1.50	1.70	0.051	0.059	0.067	
е	0.85	0.95	1.05	0.034	0.037	0.041	
L	0.20	0.40	0.60	0.008	0.016	0.024	
HE	2.50	2.75	3.00	0.099	0.108	0.118	
θ	0°	_	10°	0°	_	10°	

- STYLE 6: PIN 1. COLLECTOR 2. COLLECTOR
 - 3. BASE

4.

EMITTER COLLECTOR COLLECTOR 5. 6.

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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